

NCE0260P

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE0260P uses advanced trench technology and design to provide excellent RDS(ON) with low gate charge. It can be used in a wide variety of applications.

General Features

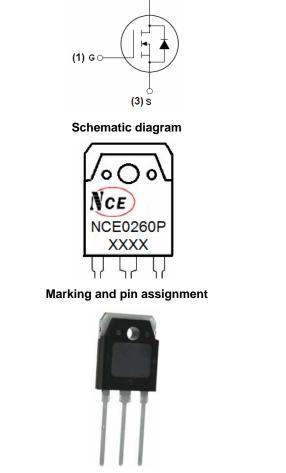
- V_{DS} =200V,I_D =60A
 R_{DS(ON)} <32mΩ @ V_{GS}=10V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



(2) D

TO-3P top view

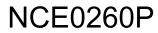
Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE0260P	NCE0260P	TO-3P	-	-	-

Absolute Maximum Ratings (T_c=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	VDS	200	V	
Gate-Source Voltage	Vgs	±20	V	
Drain Current-Continuous	Ι _D	60	А	
Drain Current-Continuous(Tc=100℃)	I _D (100℃)	42	А	
Pulsed Drain Current	I _{DM}	280	А	
Maximum Power Dissipation	PD	300	W	
Derating factor		2.0	W/°C	
Single pulse avalanche energy (Note 5)	E _{AS}	506	mJ	
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C	





Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	oc 0.5	°C/W
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Electrical Characteristics (T_C=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	200	220	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =200V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·					
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	2	3.2	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =20A	-	24	32	mΩ
Forward Transconductance	g fs	V _{DS} =5V,I _D =30A	40	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	N/ 50)()/ 0)/	-	6200	-	PF
Output Capacitance	C _{oss}	V_{DS} =50V, V_{GS} =0V,	-	950	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	460	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	33	-	nS
Turn-on Rise Time	tr	V_{DD} =100V, R _L =15 Ω	-	20	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _G =2.5Ω	-	21	-	nS
Turn-Off Fall Time	t _f		-	31	-	nS
Total Gate Charge	Qg	V/ 400V/J 00A	-	130		nC
Gate-Source Charge	Q _{gs}	V_{DS} =100V,I _D =30A,	-	36		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	46		nC
Drain-Source Diode Characteristics						•
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =30A	-		1.2	V
Diode Forward Current (Note 2)	I _S		-	-	60	А
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 30A	-	42		nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3) - 66			nC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

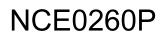
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition: j=25 $^\circ\!\mathrm{C}$,V_DD=50V,VG=10V,L=0.5mH,Rg=25\Omega

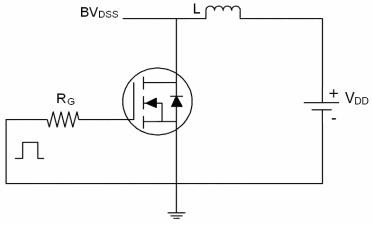


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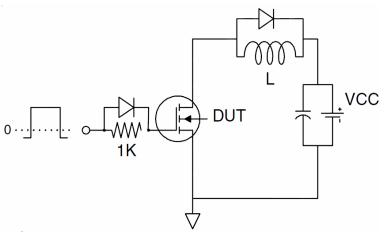




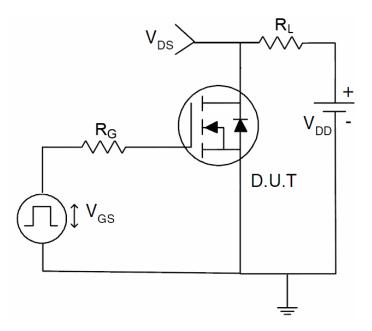
Test Circuit 1) E_{AS} test Circuits



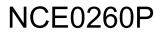
2) Gate charge test Circuit



3) Switch Time Test Circuit





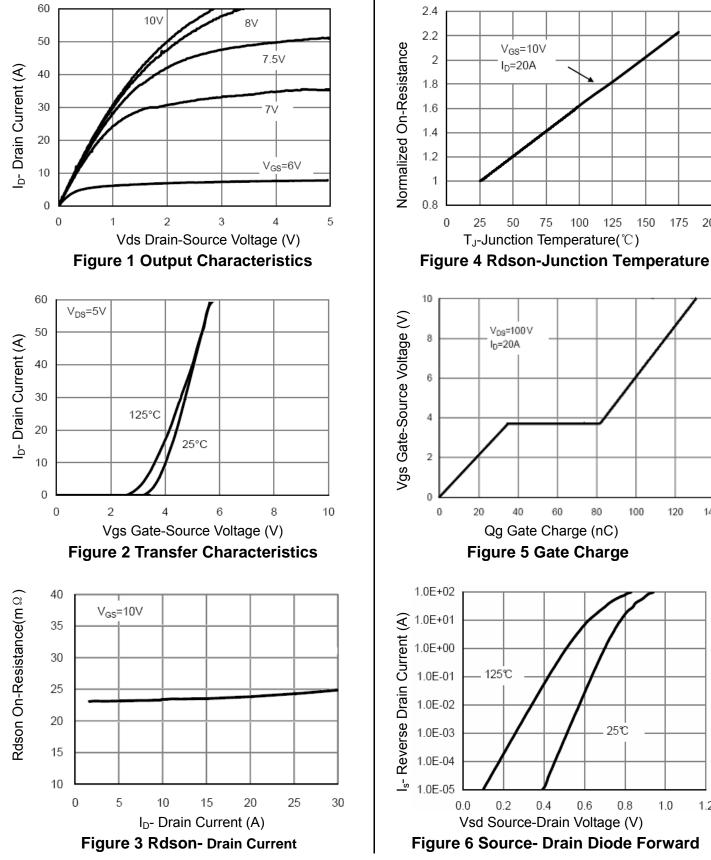


200

120

140





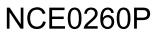
1.2

1.0



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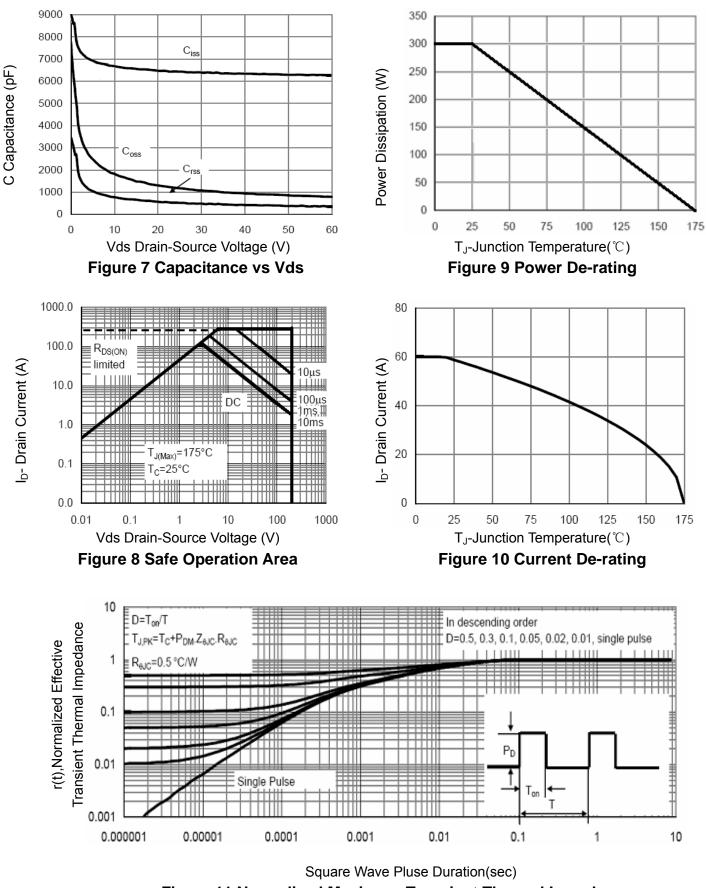
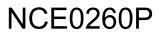


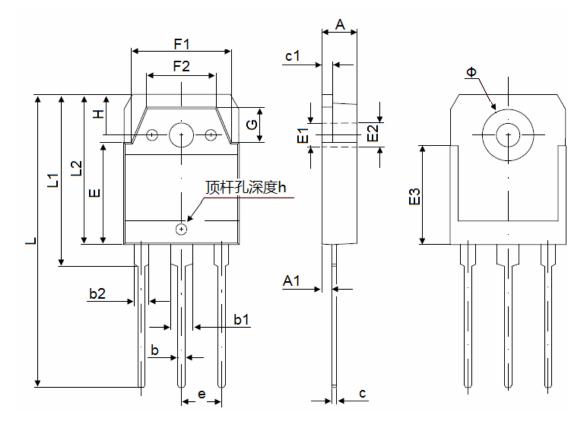
Figure 11 Normalized Maximum Transient Thermal Impedance



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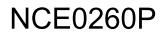
TO-3P Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
А	4.600	5.000	0.181	0.197	
A 1	1.200	1.600	0.047	0.063	
b	0.800	1.200	0.031	0.047	
b1	2.800	3.200	0.110	0.126	
b2	1.800	2.200	0.071	0.087	
С	0.500	0.700	0.020	0.028	
c1	1.450	1.650	0.057	0.065	
D	15.450	15.850	0.606	0.622	
E	13.700	14.100	0.539	0.555	
E 1	3.200	İREF	0.126 REF		
E 2	3.300	REF	0.130 REF		
E 3	13.45	OREF	0.530 REF		
F 1	13.400	13.800	0.528	0.543	
F 2	9.400	9.800	0.370	0.386	
L	39.900	40.300	1.571	1.587	
L1	23.200	23.600	0.913	0.929	
L2	20.300	20.600	0.799	0.811	
Φ	6.900	7.100	0.272	0.280	
G	5.150	5.550	0.203	0.219	
e	5.450) TYP	0.215 TYP		
Н	5.000	REF	0.197 REF		
h	0.000	0.300	0.000	0.012	







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